

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Masayuki Fukuda	11/30/2009
Katsuhiko Nakai	11/30/2009
RECEIVING PARTY DATA	
Name:	Siltronic AG
Street Address:	Hanns-Seidel-Platz 4
City:	Munich
State/Country:	GERMANY
Postal Code:	81737
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12637850
CORRESPONDENCE DATA	
Fax Number:	(248)358-3351
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	2483584400
Email:	LFreismuth@brookskushman.com
Correspondent Name:	BROOKS KUSHMAN P.C.
Address Line 1:	1000 TOWN CENTER
Address Line 2:	TWENTY-SECOND FLOOR
Address Line 4:	SOUTHFIELD, MICHIGAN 48075
ATTORNEY DOCKET NUMBER:	WSAG 0254 PUS
NAME OF SUBMITTER:	Lidia Freismuth
Total Attachments: 1 source=Assignment#page 1.tif	

CH \$40.00 12637850

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we, **Masayuki Fukuda** of 202-23-15 Murozumi-Omachi, 743-0072 Hikari, Yamaguchi, Japan, and **Katsuhiko Nakai** of 2-3-34 Shinkai, Murozumi, 743-0071 Hikari, Yamaguchi, Japan, respectively, do hereby assign, sell and set over to **Siltronic AG**, a corporation of Germany, located at Hanns-Seidel-Platz 4, 81737 München, Germany, hereinafter referred to as the ASSIGNEE, its successors, assigns or other legal representatives, the entire right, title and interest, domestic and foreign, in and to the inventions and discoveries in

SILICON WAFER AND METHOD OF MANUFACTURING THE SAME

including the right of said ASSIGNEE, its successors, assigns or other legal representatives to make applications and to receive Letters Patent for said inventions and discoveries in any and all foreign countries in its or their own name or names, or in our names, at its or their election, and we hereby assign, sell and set over to said ASSIGNEE, its successors, assigns or other legal representatives, all rights of priority, including any provisional applications, in and to said inventions and discoveries in all countries, including all applications claiming benefit of the filing date hereof, continuations, continuations-in-part, divisionals, reexaminations and reissue applications.

And we hereby agree for ourselves, our heirs, successors, assigns or other legal representatives to execute any and all papers, including applications for Letters Patent of any and all kinds and in any and all countries and to perform any and all acts which said ASSIGNEE, its successors, assigns or other legal representatives may deem necessary to secure thereto the rights herein assigned, sold and set over.

And we hereby represent and warrant that we have not granted any rights inconsistent with the rights granted herein.

Date: 11 / 30 / 2009

M. Fukuda
Masayuki Fukuda

Date: 11 / 30 / 2009

Kh. Nakai
Katsuhiko Nakai